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APPLICATION NO. FILING DATE FIRST NAMED INVENTOR ATTORNEY DOCKET NO. CONFIRMATION NO. 09/484,437 01/18/2000 Tongbi Jiang M4065.0226/P226 9698 24998 04/02/2003 7590 DICKSTEIN SHAPIRO MORIN & OSHINSKY LLP **EXAMINER** 2101 L STREET NW MITCHELL, JAMES M WASHINGTON, DC 20037-1526 ART UNIT PAPER NUMBER 2827

DATE MAILED: 04/02/2003

Please find below and/or attached an Office communication concerning this application or proceeding.

"		Application No		Applicant(s)
Office Action Summary		09/484,437		JIANG, TONGBI,
		Examiner		Art Unit
		James Mitchell		2827
Period fo	The MAILING DATE of this communication approximation of the communication approximation approxima	opears on the cove	r sheet with the c	orrespondence address
- External Action Actio	ORTENED STATUTORY PERIOD FOR REP MAILING DATE OF THIS COMMUNICATION assions of time may be available under the provisions of 37 CFR 1 SIX (6) MONTHS from the mailing date of this communication. a period for reply specified above is less than thirty (30) days, a respective period for reply is specified above, the maximum statutory period are to reply within the set or extended period for reply will, by statuted period by the Office later than three months after the mailined patent term adjustment. See 37 CFR 1.704(b).	136(a). In no event, how ply within the statutory mind will apply and will expire the application to the cause the application to the second secon	ever, may a reply be time nimum of thirty (30) days SIX (6) MONTHS from to become ARANDONED	ely filed  will be considered timely.  he mailing date of this communication.
1)🖂	Responsive to communication(s) filed on <u>05</u>	February 2003		
2a) <u></u>		his action is non-fi	nal	
3)□ Dispositi	Since this application is in condition for allow closed in accordance with the practice unde on of Claims	vance except for fo	rmal matters, pro	osecution as to the merits is 53 O.G. 213.
4)🖂	Claim(s) 1-20,31 and 32 is/are pending in the	e application.		
4a) Of the above claim(s) is/are withdrawn from consideration.				
	Claim(s) is/are allowed.		2001.	
6)⊠ Claim(s) <u>1-20,31 and 32</u> is/are rejected.				
7) Claim(s) is/are objected to.				
	Claim(s) are subject to restriction and/o	or election require	mant	
	on Papers	or cicolion require	nent.	
9)□ T	he specification is objected to by the Examine	er.		
	he drawing(s) filed on is/are: a) acce		ed to by the Exam	iner.
	Applicant may not request that any objection to the			
11)∐ T	he proposed drawing correction filed on			
	If approved, corrected drawings are required in re			•
12)∏ T	he oath or declaration is objected to by the Ex	kaminer.		
Priority u	nder 35 U.S.C. §§ 119 and 120			
13) 🗌 📝	Acknowledgment is made of a claim for foreig	n priority under 35	U.S.C. § 119(a)-	(d) or (f).
	All b)☐ Some * c)☐ None of:			
1	1. Certified copies of the priority document	ts have been recei	ved.	
2	2. Certified copies of the priority document			n No.
	B. Copies of the certified copies of the prio application from the International Buse the attached detailed Office action for a list	rity documents hav	/e been received	in this National Stage
	knowledgment is made of a claim for domesti			
a)	☐ The translation of the foreign language procknowledgment is made of a claim for domest	visional applicatio	n has been recei	ved.
\ttachment(s			- <del>-</del>	
) Notice	of References Cited (PTO-892) of Draftsperson's Patent Drawing Review (PTO-948) ation Disclosure Statement(s) (PTO-1449) Paper No(s)	5) ]	nterview Summary (F Notice of Informal Par Other:	PTO-413) Paper No(s) tent Application (PTO-152)
	emark Office			

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#### **DETAILED ACTION**

## Claim Rejections - 35 USC § 112

The following is a quotation of the first paragraph of 35 U.S.C. 112:

The specification shall contain a written description of the invention, and of the manner and process of making and using it, in such full, clear, concise, and exact terms as to enable any person skilled in the art to which it pertains, or with which it is most nearly connected, to make and use the same and shall set forth the best mode contemplated by the inventor of carrying out his invention.

Claims 1-20, 31 and 32 rejected under 35 U.S.C. 112, first paragraph, as containing subject matter which was not described in the specification in such a way as to reasonably convey to one skilled in the relevant art that the inventor(s), at the time the application was filed, had possession of the claimed invention. A partially cured adhesive that remains voidless after outgassing.

Applicant is required to cancel the new matter in the reply to this Office Action.

# Claim Rejections - 35 USC § 103

The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

(a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.

Claims 1-20, 31 and 32 are rejected under 35 U.S.C. 103(a) as being unpatentable over applicant's admitted prior art (APA) in combination with Forray (U.S 2002/0062923).

APA (Fig.1) discloses a semiconductor device comprising: affixing a solder mask (18) to a semiconductor die (12) with an adhesive (14), with electrically connecting

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contacts on a die (20) with contacts on said solder mask (22) attaching a chip to said solder mask.

The admitted prior art does not appear to disclose an adhesive layer that is curable at a temperature below about 100 degree Celsius and at a temperature about 20-50 degrees than a glassy temperature of said adhesive layer with contact substantially free from contaminants outgassed from said solder mask or an encapsulant molded over the die.

However, Forray utilizes a bismaleimide partially cured adhesive with a semiconductor device that remains voidless after outgassing (Abstract: "reduced void formation upon *curing*"; Paragraph 0048), and is fully curable at a temperature below about 100 degree Celsius (Par. 0007, Lines 6-8), wherein the adhesive is inherently cured at a temperature between 20 to 50 degrees higher than glassy temperature (Tg) of said adhesive layer (admittedly by applicant, Page 6, bismaleimide Tg is 5-10 degree Celsius); and said adhesive contains an initiators (Par. 0028, Lines 9-10) which reacts at a temperature about 100 degree Celsius.

It would have been obvious to one of ordinary skill in the art to form the device of the admitted prior art with the adhesive of Forray, in order to bond the chip and to eliminate void formation in the adhesive during a cure process as taught by Forray (Abstract; Par. 0047) and thus the contacts are inherently substantially free of contaminants (via limited outgassing because no voids formed in adhesive).

With respect to an encapsulant over the die, examiner takes official notice that encapsulating a die was well known at the time the present invention was made and

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that it would have been obvious to one of ordinary skill in the art to form an encapsulant over the die of the prior art in order to protect the die.

## Response to Arguments

Applicant's arguments with respect to claims 1-20, 31 and 32 have been considered but are most in view of the new ground(s) of rejection.

#### Conclusion

Any inquiry concerning this communication or earlier communications from the examiner should be directed to James Mitchell whose telephone number is (703) 305-0244. The examiner can normally be reached on M-F 10:30-8:00.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, David L. Talbott can be reached on (703) 305-9883. The fax phone numbers for the organization where this application or proceeding is assigned are (703) 305-3432 for regular communications and (703) 305-3230 for After Final communications.

Any inquiry of a general nature or relating to the status of this application or proceeding should be directed to the receptionist whose telephone number is (703) 308-0956.

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March 28, 2003

JUE 9M

DAVID E. GRAYBILL PRIMARY EXAMINER